



CALL FOR ABSTRACTS

14th Annual MEPTEC MEMS Technology Symposium

Wednesday, May 11, 2016, Holiday Inn San Jose, San Jose, California

The MEPTEC MEMS program committee would like to invite you to submit an abstract for the 14th Annual MEPTEC MEMS Technology Symposium. The theme is “Advancing MEMS for Today’s Exploding Demands”. **The deadline to submit is March 17.**

The requirements are minimal. Instead of writing a paper you will submit slides for presentation. Deadlines and Guidelines will be sent to you upon approval of your abstract.

NOTE: Please obtain attendance and travel approval prior to submitting. When a paper is accepted it is our expectation that you have budget approval for travel costs (no charge for attending).

Topics of interest

MEMS Design

- Reusability
- Systems design
- Design for reliability
- Security
- Managing complexity

Process Technologies

- Cost effective processes
- Process integration
- Process re-use/standardization

Packaging

- Multi-die packaging
- Special purpose packaging
- Package standardization

Test

- Design for MEMS testing
- High volume automated test
- Multi-die testing,

Emerging Technologies

- Flexible, hybrid, printed MEMS and sensors

****See page two for instructions and other information ****

Instructions

- To submit your abstract click here: <https://fs24.formsite.com/meptec/form124/index.html>
- Abstract should be 250-300 words to cover the objectives of the presentation, indicate relevance to the conference theme and audience and have a call to action for the industry.
- Questions to consider when writing abstract:
 - Is your topic relevant to the audience and aligned with the theme of the conference?
 - What segments of the MEMS/Sensor supply chain would benefit from the information?
 - Foundries
 - Materials and Equipment Suppliers
 - Designers
 - Device Producers
 - Assembly, Packing and Test
 - Integrators
 - End Users
 - All the above
 - Is there anything new and groundbreaking in the presentation that is newsworthy or has not been presented before?

Important Dates

Deadline for submission: March 17

Notification of acceptance: March 31 (or earlier)

Deadline for slides: April 15

Organizing committee:

- Matt Apanius, SMART Microsystems LTD
- Sean Cahill, Maxim Integrated Products
- Mary Ann Maher, SoftMEMS
- Bettina Weiss, SEMI
- Steve Whalley, MEMS and Sensors Industry Group

For all general inquiries, please contact Bette Cooper at bcooper@meptec.org or call 650-714-1570.